

Bétina Bebey, EMEA Product Marketing Manage for High Voltage Gate Drivers, NXP

Bodo's Wide Bandgap Event 2025

Making WBG Designs Happen

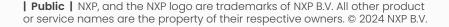
GaN



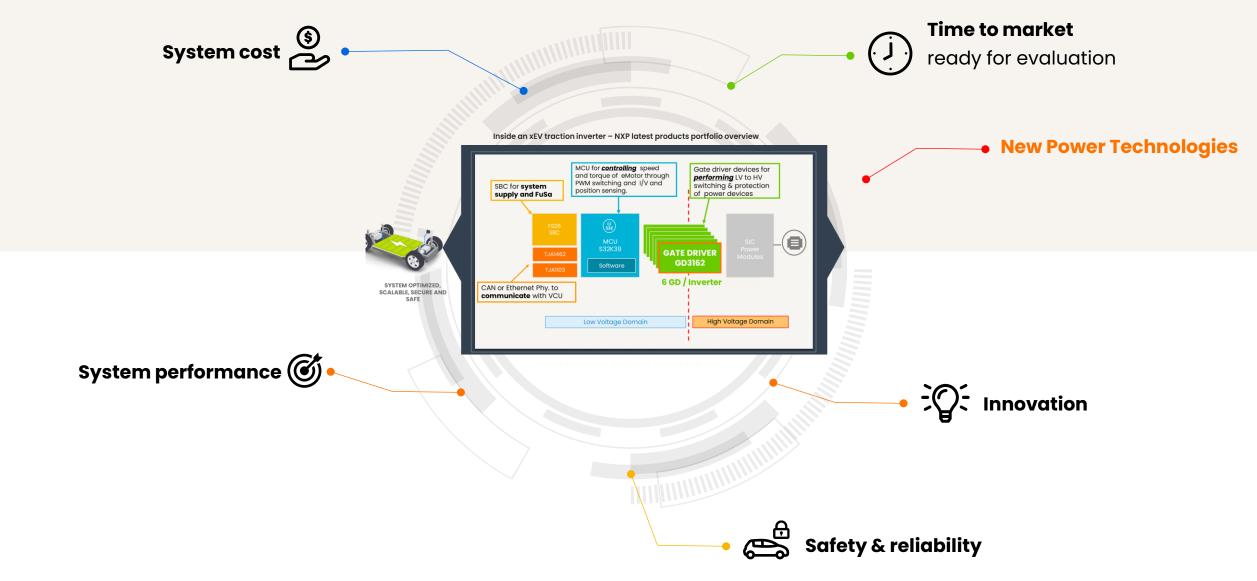
The adoption of Hybrid switches & GaN technologies for traction inverter

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Key challenges for traction inverter system



Trends in Power Switch Technology

	IGBT Si-MOSFET	SIC-MOSFET	Hybrid Switch: Si+SiC or IGBT+GaN	GaN Norm-ON Norm-OFF
Device Cost	\$	\$\$\$	\$\$	\$\$
Device TTM	In production	In production	By 2026? / >2028?	By 2028?
Efficiency impact	-	+	+	++
BOM cost impact	_	_	+	++
Challenges	Efficiency	Cost Capacity (today)	Control complexity Adoption vs SiC price	Reliability & Safety Technology for 800V

Power GaN for traction inverter [high-current]

Types of GaN

D-Mode:

- Direct drive
- Cascode



E-mode:

- Ohmic Gate
- Schottky Gate



Vertical GAN

Benefits

- High switching speed
- Low switching losses
- Low gate charge
- Can be implemented on large diameter Si wafers as substrate
- Lower cost to build vs SiC

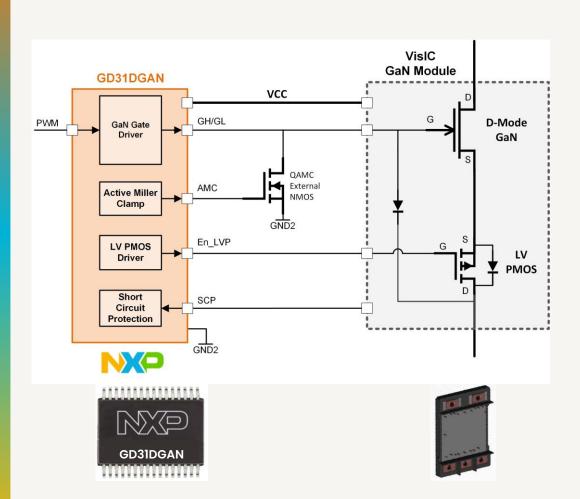
Challenges

- D-Mode challenges:
 - Normally ON safety management
- E-Mode challenges:
 - Gate reliability
 - Low gate Vth
- All GAN challenges:
 - High EMI
 - Paralleling for high I
 - Needs fast SC protection

NXP's GaN HVGD offering enables **GaN** in inverter applications

NXP GD31DGAN enables D-mode GaN for traction inverter with safety in mind

- Safely manage D-mode power up/down
- Tackle safety challenges of D-mode through key features like AMC and series PMOS management
- Fast/Reliable SC detection



Demonstration platform showcasing a dual traction inverter using Dmode GaN

3-party collaboration

- VisIC D3GAN Gen-2 power switch/module
- NXP dedicated GaN driver test chip: GD31DGAN
- AVL e-drive control software

Dual Traction Inverter Specification:

- 400V & 2x500A,rms
- Switching Speed up to 15kHz
- Peak Efficiency >99,5%

Targeted collaboration outcome:

- PoC vehicle driving with GaN inverter
- System level performance data comparison SiC vs GaN

NXP GD31DGaN EVB

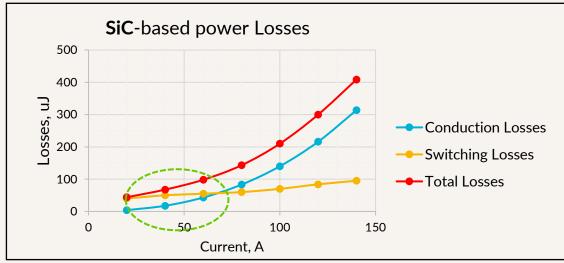


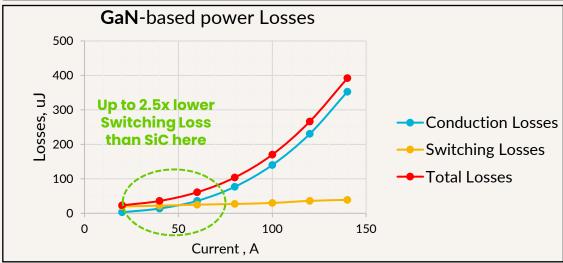




AVL inverter

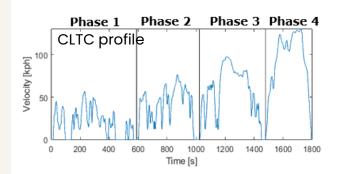
Evaluation results: GAN vs SiC for inverter application

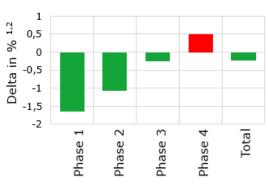




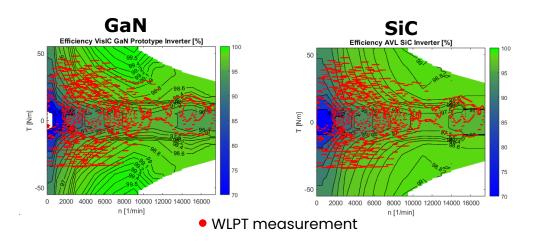
GaN outperforms SiC in Switching & **Total losses at partial load**

AVL inverter using Visic GaN Gen1 efficiency testing @ same e-machine and same speed & load





- SiC outperforms GaN
- GaN outperforms SiC



NXP GD and VisIC GaN delivers better efficiency than SiC, helping drivers go farther on less power

Evaluation results: Double pulse testing

Test configuration

- GD31DGAN + Visic GaN power module
- 400V / 300A @ RT
- Switching energy testing







xFRDMGD3162VSEVM board + Visic Module

Tests results: Double-pulse test: 300A / 400 V





NXP enables the Future of xEV Traction Inverters

xEV traction inverters face evolving challenges

- Higher efficiency
- Compactness, thermal management
- Cost optimization

NXP's HVGDs are designed to meet these needs

- Support for emerging technologies like Power GaN
- Design with safety in mind for d-mode GAN
- Compatibility with new inverter architectures like 3L inverter

NXP aims to be the trusted partner for customers exploring

- Power GAN for traction inverter
- Next trend of inverter architectures
- Hybrid switch adoption

Let's shape the future of electrified mobility— **together**.



Get in touch

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